SD Memory Card Connectors

DM1 Series



Features

1. Withstands higher force of card insertion

Metal cover extends over the back of the connector allowing it to withstand force of up to 400N (static load) when dropped or accidentally hit. (Fig.1)

2. No damage to the card when accidentally pulled-out

The connectors will release the card when a moderate pull-out force of about 4N is applied. There will be no damage to the lock components and all connector functions will not be affected. (Fig.2)

3. Accidental card fall-out prevention

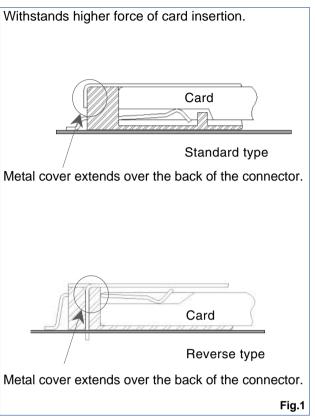
Built-in lock feature holds the card securely in place. (Fig.3)

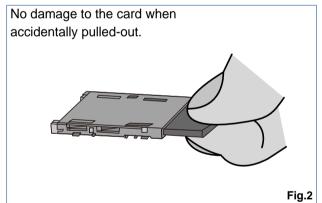
4. Reliable Card Insertion and Withdrawal

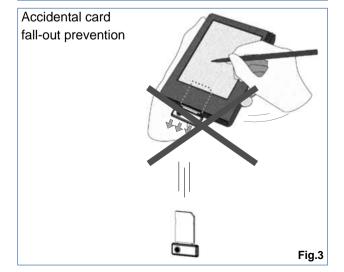
Built-in Push-in / Push-out ejection mechanism assures simple and reliable card insertion and withdrawal.

5. Designed to accept Secure Digital I/O card (Built-in Ground Contact)

The connector allows use of various expansion modules, including the Bluetooth communication modules.







2021.2(2)

■Product Specifications

Poting	Current rating 0.5A DC	Operating temperature range : -25°C to +85°C (Note 1)	Operating humidity range : Relative humidity 95%
Rating	Voltage rating 125V AC	Storage temperature range : -40°C to +85°C (Note 2)	max. (No condensation)

Item	Specification	Conditions	
1. Insulation resistance	1000MΩ min. (Initial value)	500V DC	
2. Withstanding voltage	No flashover or insulation breakdown	500V AC / one minute	
3. Contact resistance	100mΩ max. (Initial value)	100mA DC	
4. Vibration	No electrical discontinuity of 100ns or more	Frequency: 10 to 55Hz, single amplitude of 0.75mm, 2 hours / 3 axis	
5. Humidity Contact resistance : $40m\Omega$ max. from initial value Insulation resistance : $100M\Omega$ min.		96 hours at temperature of 40 $^{\circ}\!$	
6. Temperature cycle Contact resistance : $40m\Omega$ max. from initial value Insulation resistance : $100M\Omega$ min.		Temperature : $-55^{\circ}\text{C} \rightarrow +5^{\circ}\text{C}$ to $+35^{\circ}\text{C} \rightarrow +85^{\circ}\text{C} \rightarrow +5^{\circ}\text{C}$ to $+35^{\circ}\text{C}$ Duration : $30 \rightarrow 5 \rightarrow 30 \rightarrow 5$ (Minutes) 5 cycles	
7. Durability (mating/un-mating)	Contact resistance : $40m\Omega$ max. from initial value	10000 cycles at 400 to 600 cycles per hour	
8. Resistance to soldering heat No deformation of components affecting performance		Reflow : At the recommended temperature profile Manual soldering : 350°C for 3 seconds	

Note1: Includes temperature rise caused by current flow.

Note2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating Temperature Range and Humidity range covers non-conducting condition of installed connectors in storage, shipment or during transportation.

■Materials / Finish

Component	Material	Finish	Remarks
Insulator	Heat resistant thermoplastic compound	int thermoplastic compound Color : Black	
Contacts	Phosphor bronze	Contact area : Gold plating Termination area : Tinned copper plating	
Cover	Stainless steel	Termination area : Tinned copper plating	
Others	Stainless steel Piano wire	Nickel plating	

■ Product Number Structure

Refer to the chart below when determining the product specifications from the product number.

Please select from the product numbers listed in this catalog when placing orders.

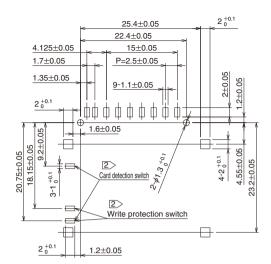
 Series name 	DM1	3 Terminal type
2 Connector type	AA : Standard receptacle	SF : Right angle surface mount
	B : Reverse receptacle	DSF: Reverse right angle surface mount
		4 Eject mechanism codes
		PEJ: Card Push insert/Push withdraw

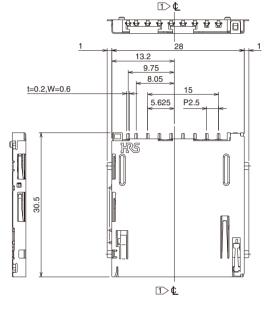
■Standard type

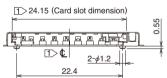


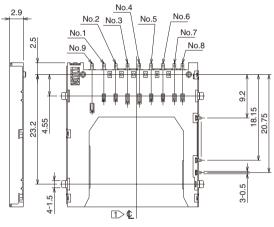
Part No.	HRS No.	
DM1AA-SF-PEJ(82)	609-0004-8 82	

● PCB mounting pattern





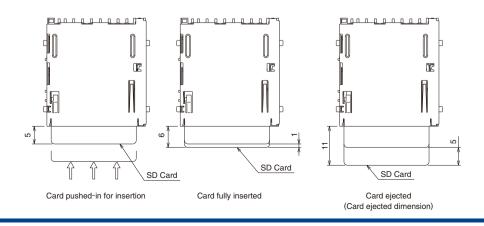




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Card detection switch		Write protection switch				
When card is When card		When card is	When card is inserted			
No yet inserted	is inserted	No yet inserted	WRITE PROTECT	WRITE ENABLE		
OPEN	CLOSE	OPEN	OPEN	CLOSE		
0 0	\odot	0 0	0 0	⊕—•		

Weight:2.2g

◆Card insertion/withdrawal dimensions

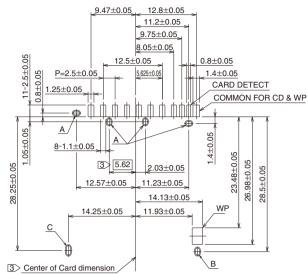


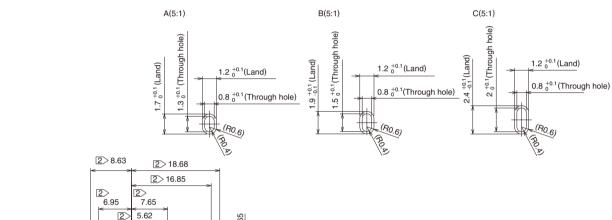
■Reverse type

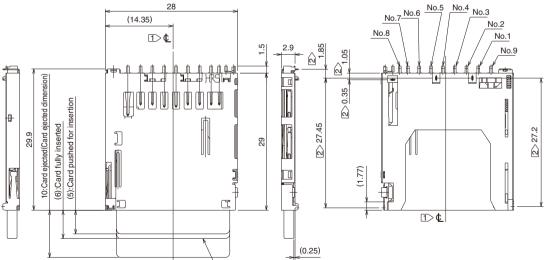


Part No.	HRS No.	
DM1B-DSF-PEJ(92)	609-0003-5 92	

▶ PCB mounting pattern







SD Card

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F-V	8	U 18
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1> **L**indicates the center line of the card slot.

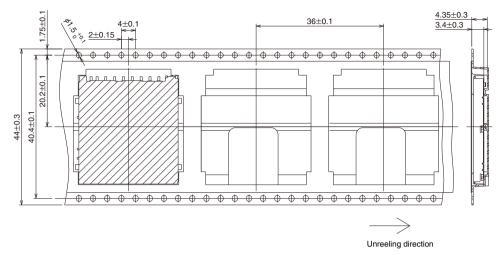
indicates the dimension of DIP terminals.

Card detection switch		Write protection switch		
When card is	When card	When card is When card is		is inserted
not yet inserted	is inserted	not yet inserted	WRITE PROTECT	WRITE ENABLE
OPEN	CLOSE	OPEN	OPEN	CLOSE
00	○ 	00	00	0—0

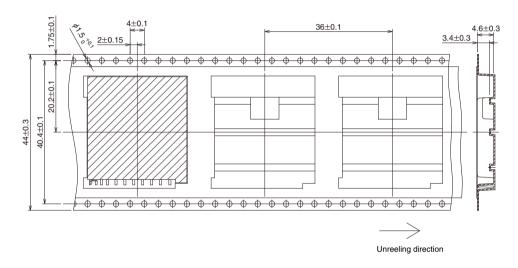
Weight:2.1g

▶ Packaging specifications

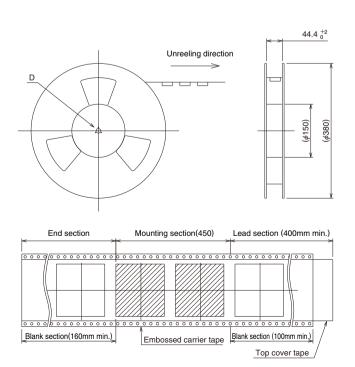
●Embossed Carrier Tape Dimensions (Standard type) 450 pcs/reel



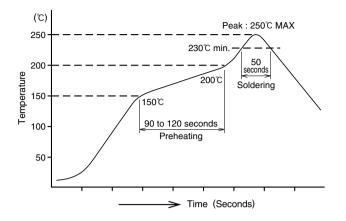
●Embossed Carrier Tape Dimensions(Reverse type) 450 pcs/reel



●Reel dimensions



●Recommended Temperature Profile



HRS test condition

Solder method : Reflow, IR/hot air

Environment : Room air

Solder composition: Paste, 96.5%Sn/3.0%Ag/0.5%Cu

(Senju Metal Industry, Co., Ltd.'s Part Number:M705-GRN360-K2-V)

Test board : Glass epoxy 60mm×100mm×1.0mm thick

Metal mask : 0.15mm thick Number of reflow cycles : 2cycles max.

The temperature profiles shown are based on the above conditions.

In individual applications the actual temperature may vary, depending on solder paste type, volume / thickness and board size / thickness. Consult your solder paste and equipment manufacturer for specific recommendations.



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